

80mW, Capless, Stereo Headphone Amplifier with Shutdown

GENERAL DESCRIPTION

The SGM4917 stereo headphone amplifier is designed for portable equipment where board space is at a premium. The SGM4917 uses capless architecture to produce a ground-referenced output from a single power supply, eliminating the need for large DC-blocking capacitors for output, saving cost, board space, and component height. Additionally, for SGM4917B, the gain is set internally (-2V/V), further reducing component count. For SGM4917A, the gain can be adjusted by external feedback resistors.

The SGM4917 delivers up to 80mW per channel into a 32Ω load and has low 0.02% THD+N. A -78dB power supply rejection ratio (PSRR) at 217Hz allows this device to operate from noisy digital supplies without an additional linear regulator. Comprehensive click-and-pop circuitry suppresses audible clicks and pops on startup and shutdown.

The SGM4917 operates from a single 2.7V to 5.5V supply, consumes only 2.7mA supply current, and is specified over the extended -40°C to +85°C temperature range. The SGM4917 is available in a Green TQFN-3×3-16L package.

FEATURES

- SGM4917A: External Feedback Gain Network SGM4917B: Fixed -2V/V Gain
- No Bulky DC-Blocking Capacitors Required
- Ground-Referenced Outputs Eliminate DC-Bias Voltage on Headphone Ground Pin
- No Degradation of Low-Frequency Response Due to Output Capacitors
- Differential Inputs for Enhanced Noise Cancellation
- 80mW into 32Ω Load from 5V Power Supply at THD+N = 0.1% (TYP, per Channel)
- Low 0.02% THD+N
- High PSRR (-78dB at 217Hz)
- Integrated Click-and-Pop Suppression
- 2.7V to 5.5V Single Supply Operation
- Low Quiescent Current (2.7mA at V_{DD} = 5V)
- Shutdown Control
- Under-Voltage Lockout Function
- -40°C to +85°C Operating Temperature Range
- Available in Green TQFN-3×3-16L Package

APPLICATIONS

Notebook PCs

Cellular Phones

PDAs

MP3 Players

Smart Phones

Portable Audio Equipment

PACKAGE/ORDERING INFORMATION

MODEL	GAIN (V/V)	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	MPERATURE ORDERING I		PACKING OPTION
SGM4917A	ADJ	TQFN-3×3-16L	-40°C to +85°C	SGM4917AYTQ16G/TR	4917AQ XXXXX	Tape and Reel, 3000
SGM4917B	-2	TQFN-3×3-16L	-40°C to +85°C	SGM4917BYTQ16G/TR	4917BQ XXXXX	Tape and Reel, 3000

NOTE: XXXXX = Date Code and Vendor Code.

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

PV _{SS} to SV _{SS}	0.3V to +0.3V
PGND to SGND	0.3V to +0.3V
PV _{DD} to SV _{DD}	0.3V to +0.3V
PV_DD and SV_DD to PGND or SGND	0.3V to +6V
PV_SS and SV_SS to PGND or SGND	6V to +0.3V
IN to SGND(SV _{SS} - 0	0.3V) to (SV _{DD} + 0.3V)
SHDN to SGND	$0.3V \text{ to } (SV_{DD} + 0.3V)$
OUT to SGND(SV _{SS} - 0	0.3V) to (SV _{DD} + 0.3V)
C1P to PGND	$0.3V \text{ to } (PV_{DD} + 0.3V)$
C1N to PGND (F	$PV_{SS} - 0.3V$) to + 0.3V
Output Short Circuit to GND or V_{DD}	Continuous
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (Soldering, 10s)	+260°C
ESD Susceptibility	
HBM	2000V
HBM (Output pins to Supply and Grour	nd pins) 4000V
MM	150V

RECOMMENDED OPERATING CONDITIONS

Supply Voltage Range	2.7V to 5.5V
Operating Temperature Range	40°C to +85°C

OVERSTRESS CAUTION

Stresses beyond those listed may cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational section of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

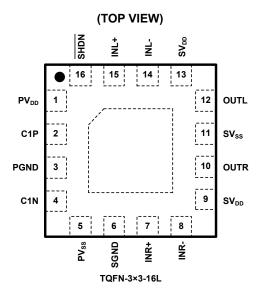
ESD SENSITIVITY CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time.

PIN CONFIGURATION



PIN DESCRIPTION

PIN	NAME	DESCRIPTION
1	PV _{DD}	Charge-Pump Power Supply. Powers charge-pump inverter, charge-pump logic, and oscillator. Connect to positive supply (2.7V to 5.5V). Bypass with a $1\mu F$ capacitor to PGND as close to the pin as possible.
2	C1P	Flying Capacitor Positive Terminal.
3	PGND	Power Ground. Connect to ground.
4	C1N	Flying Capacitor Negative Terminal.
5	PVss	Charge-Pump Output. Connect to SV _{SS} .
6	SGND	Signal Ground. Connect to ground.
7	INR+	Noninverting Right-Channel Audio Input.
8	INR-	Inverting Right-Channel Audio Input.
9,13	SV _{DD}	Amplifier Positive Power Supply. Connect to positive supply (2.7V to 5.5V). Bypass with a 1μ F capacitor to SGND as close to the pin as possible.
10	OUTR	Right-Channel Output.
11	SV _{SS}	Amplifier Negative Power Supply. Connect to PV _{SS} .
12	OUTL	Left-Channel Output.
14	INL-	Inverting Left-Channel Audio Input.
15	INL+	Noninverting Left-Channel Audio Input.
16	SHDN	Active-Low Shutdown Input.
Exposed Paddle	-	Exposed Paddle. Can be connected to GND or left floating.

ELECTRICAL CHARACTERISTICS

 $(PV_{DD} = SV_{DD} = 5V, PGND = SGND = 0V, \overline{SHDN} = SV_{DD}, C1 = C2 = 1μF, R_L = ∞, resistive load referenced to ground; for SGM4917A, gain = -1V/V (R_{IN} = R_F = 10kΩ); for SGM4917B, gain = -2V/V (internally set). T_A = +25°C, unless otherwise noted.) (1)$

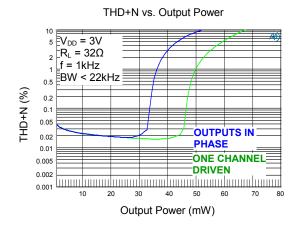
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
GENERAL			•	•	•	•
Supply Voltage Range	V_{DD}		2.7		5.5	V
Quiescent Supply Current	I _{DD}			2.7	3.7	mA
Shutdown Supply Current	I _{SHDN}	SHDN = SGND = PGND		0.01	8	μA
SHDN Input Logic High	V _{IH}		1.2			V
SHDN Input Logic Low	V _{IL}				0.4	V
SHDN to Full Operation Time	t _{son}			3.2		ms
AMPLIFIERS						
Voltage Gain	A _V	SGM4917B	-2.12	-2	-1.88	V/V
Gain Matching	ΔA_{V}	SGM4917B, between the right and left channels		0.2		%
Output Offset Voltage	V _{OS}	Between IN+ and IN-, input AC-coupled to ground (SGM4917A)	-5.5	1.1	5.5	mV
Input Impedance	R _{IN}	SGM4917B, measured at INL and INR	12.5	14.6	17	kΩ
Common Mode Rejection Ratio	CMRR	Input referred, SGM4917A		-70		dB
Power Supply Rejection Ratio	PSRR	f = 217Hz, V _{RIPPLE} = 200mV _{P-P}		-78		dB
Power Supply Rejection Ratio	FORK	$f = 10kHz$, $V_{RIPPLE} = 200mV_{P-P}$		-70		uБ
Output Power	P _{OUT}	$R_L = 32\Omega$, THD+N = 0.1%		80		mW
Output Impedance in Shutdown				2		kΩ
Total Harmonic Distortion Plus Noise	THD+N	$R_L = 32\Omega$, $P_{OUT} = 55$ mW, $f = 1$ kHz		0.02		%
Signal-to-Noise Ratio	SNR	$R_L = 32\Omega$, $P_{OUT} = 20$ mW, BW < 20 kHz		100		dB
Capacitive Drive	CL	No sustained oscillation		200		pF
Charge-Pump Oscillator Frequency	f _{OSC}		200	350	500	kHz
Crosstalk		$R_L = 32\Omega$, $V_{IN} = 200 \text{mV}_{P-P}$, $f = 10 \text{kHz}$ $A_V = -1 \text{V/V}$		90		dB
Thermal Shutdown Threshold				137		°C
Thermal Shutdown Hysteresis				11		°C

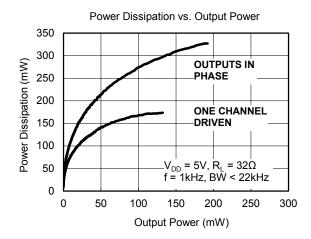
NOTE:

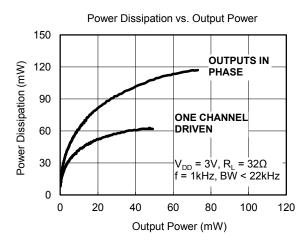
1. For C_{IN}, C1 and etc, please refer to the Functional Diagram and Typical Application on pages 8 and 9.

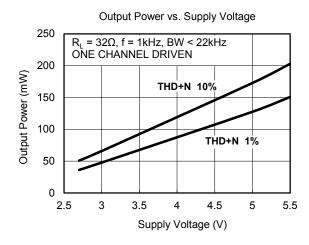
TYPICAL PERFORMANCE CHARACTERISTICS

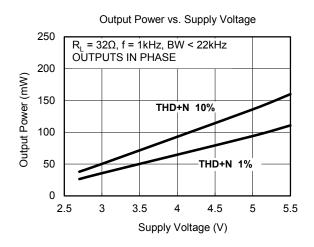
THD+N vs. Output Power $V_{DD} = 5V$ $R_L = 32\Omega$ 2 f = 1kHz BW < 22kHz 0.5 (%) N+QHJ 0.2 0.1 0.05 **OUTPUTS IN** 0.02 0.01 ONE CHANNEL 0.005 DRIVEN 0.002 0.001 100 125 150 175 Output Power (mW)



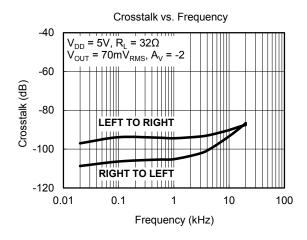


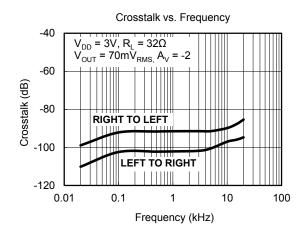


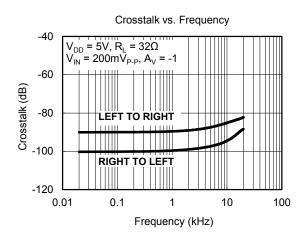


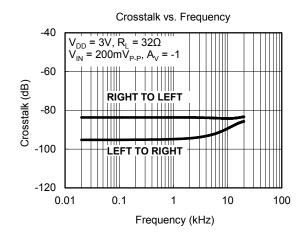


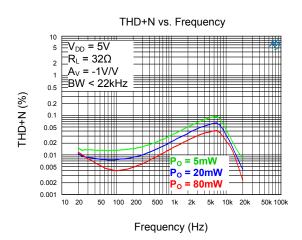
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

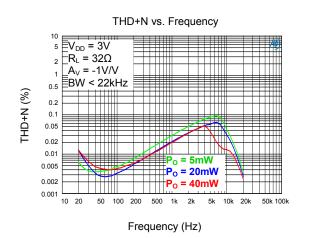




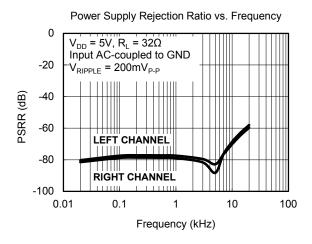


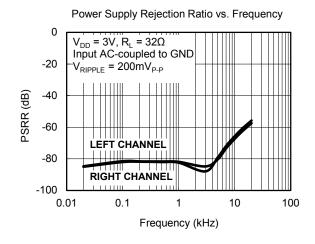


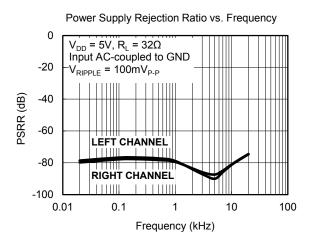


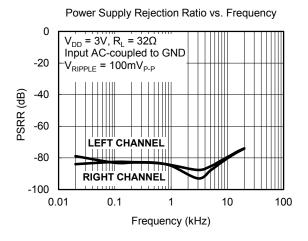


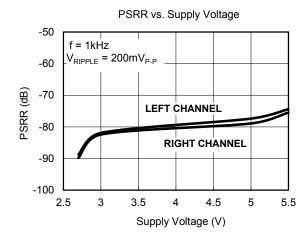
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

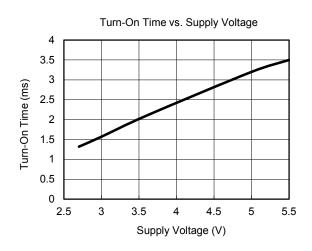












FUNCTIONAL DIAGRAM AND TYPICAL APPLICATION

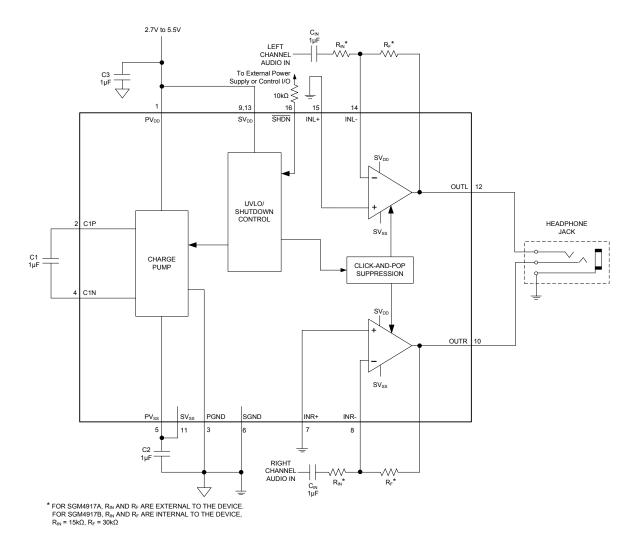
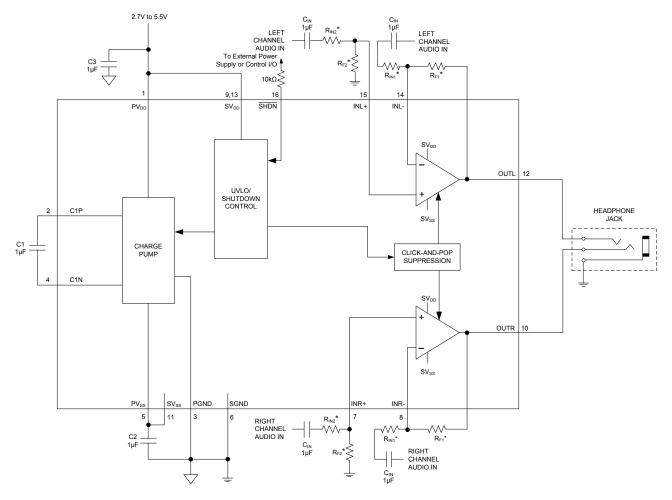


Figure 1. Typical Single-Ended Input Application Circuit

NOTES:

- 1. To ensure the normal operation of the device, decoupling capacitor (C3) must be placed as close to SGM4917 as possible. The loop length formed by C3, SV_{DD} and GND should be no longer than 1.2cm; otherwise the device will not start up at high supply voltage.
- 2. In order to get good performance, it's important to select the right C1, C2 and C3 in application. All tests are performed with circuit set up with X5R and X7R capacitors. Capacitors having high dissipative loss, such as Y5V capacitor, may cause performance degradation and unexpected system behavior.
- 3. A $10k\Omega$ resistor must be serially connected to \overline{SHDN} pin.

FUNCTIONAL DIAGRAM AND TYPICAL APPLICATION (continued)



^{*} FOR SGM4917A, R_{IN} AND R_F ARE EXTERNAL TO THE DEVICE, FOR SGM4917B, R_{IN} AND R_F ARE INTERNAL TO THE DEVICE, R_{IN1} = 15k Ω , R_{F1} = 30k Ω , R_{IN2} = 15k Ω , R_{F2} = 30k Ω

Figure 2. Typical Differential Input Application Circuit

NOTES:

- 1. To ensure the normal operation of the device, decoupling capacitor (C3) must be placed as close to SGM4917 as possible. The loop length formed by C3, SV_{DD} and GND should be no longer than 1.2cm; otherwise the device will not start up at high supply voltage.
- 2. In order to get good performance, it's important to select the right C1, C2 and C3 in application. All tests are performed with circuit set up with X5R and X7R capacitors. Capacitors having high dissipative loss, such as Y5V capacitor, may cause performance degradation and unexpected system behavior.
- 3. A 10k Ω resistor must be serially connected to $~\overline{\text{SHDN}}~$ pin.

80mW, Capless, Stereo Headphone Amplifier with Shutdown

SGM4917

REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

JULY 2017 - REV.A.2 to REV.A.3

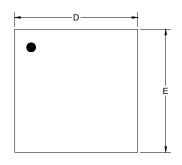
pdated Typical Application Circuit	8-9
ECEMBER 2012 – REV.A.1 to REV.A.2	
dded note for Typical Application Circuit	8-9
EPTEMBER 2012 – REV.A to REV.A.1	
dded Tape and Reel Information	11-12

Changes from Original (FEBRUARY 2012) to REV.A

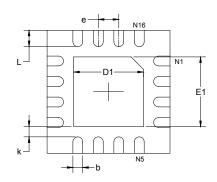
Changed from product preview to production data



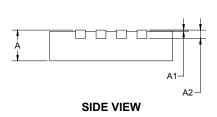
PACKAGE OUTLINE DIMENSIONS TQFN-3×3-16L

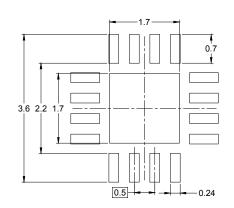


TOP VIEW



BOTTOM VIEW



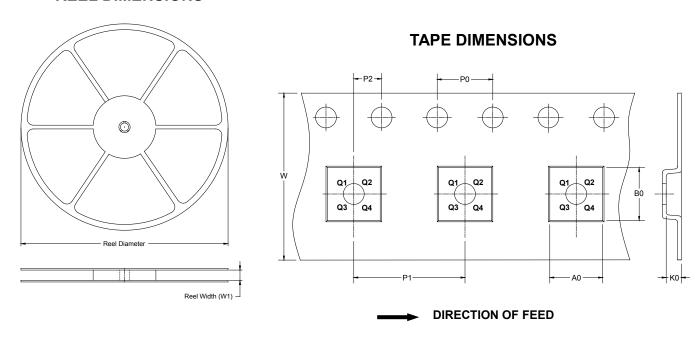


RECOMMENDED LAND PATTERN (Unit: mm)

Symbol	Dimer In Milli	nsions meters	Dimensions In Inches		
	MIN	MAX	MIN	MAX	
А	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
A2	0.203 REF		0.008 REF		
D	2.900	3.100	0.114	0.122	
D1	1.600	1.800	0.063	0.071	
E	2.900	3.100	0.114	0.122	
E1	1.600	1.800	0.063	0.071	
k	0.200 MIN		0.008	MIN	
b	0.180	0.300	0.007	0.012	
е	0.500 TYP		0.020	TYP	
L	0.300	0.500	0.012	0.020	

TAPE AND REEL INFORMATION

REEL DIMENSIONS

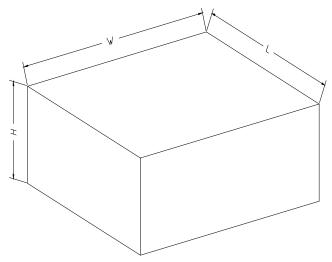


NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
TQFN-3×3-16L	13"	12.4	3.35	3.35	1.13	4.0	8.0	2.0	12.0	Q1

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton	
13"	386	280	370	5	